

2SK973(L), 2SK973(S)

Silicon N-Channel MOS FET

Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device
 - Can be driven from 5 V source
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

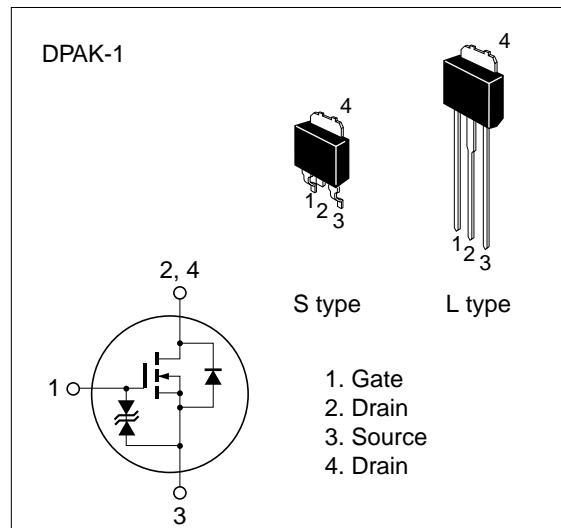


Table 1 Absolute Maximum Ratings (Ta = 25°C)

| Item | Symbol | Ratings | Unit |
|---|-----------------------|-------------|------|
| Drain to source voltage | V _{DSS} | 60 | V |
| Gate to source voltage | V _{GSS} | ±20 | V |
| Drain current | I _D | 2 | A |
| Drain peak current | I _{D(peak)*} | 8 | A |
| Body to drain diode reverse drain current | I _{DR} | 2 | A |
| Channel dissipation | P _{ch**} | 10 | W |
| Channel temperature | T _{ch} | 150 | °C |
| Storage temperature | T _{stg} | -55 to +150 | °C |

* PW ≤ 10 µs, duty cycle ≤ 1 %

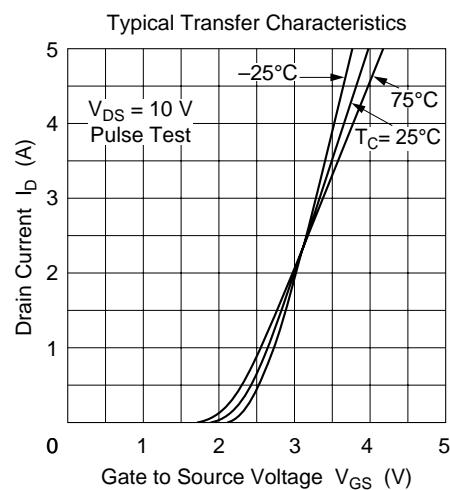
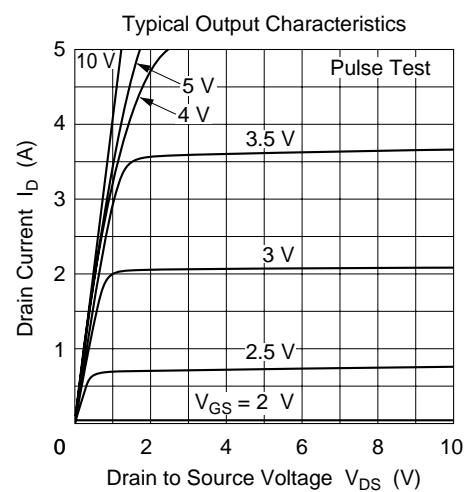
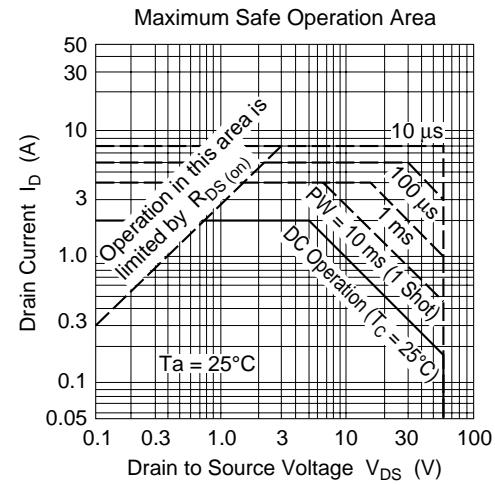
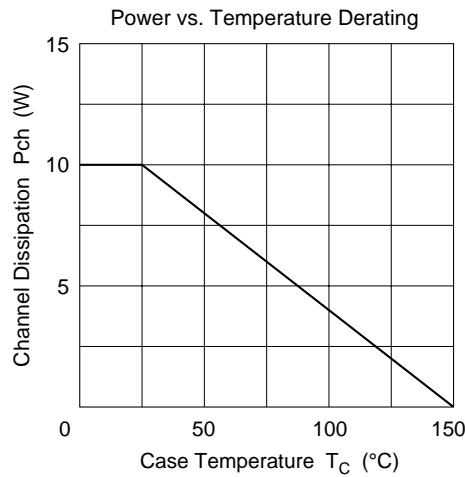
** Value at T_C = 25 °C

2SK973 (L) 2SK973 (S)

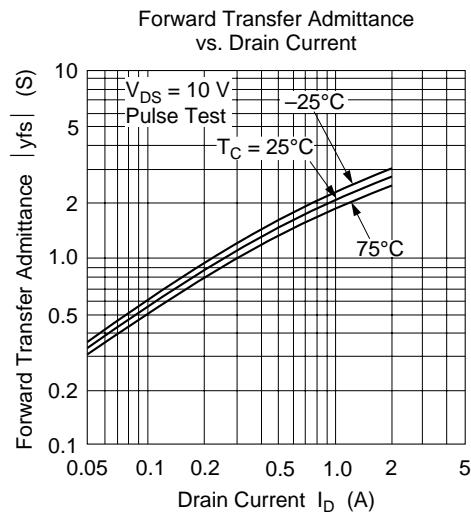
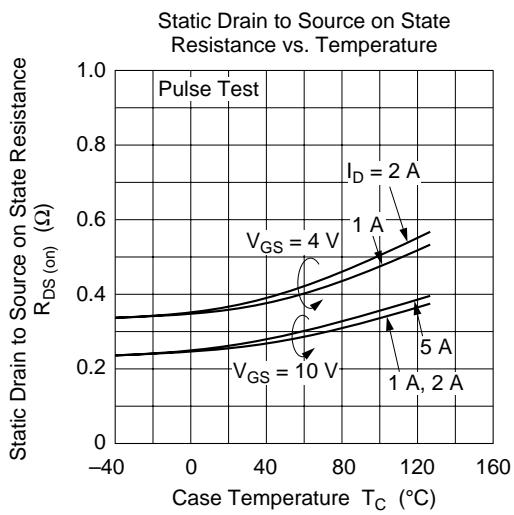
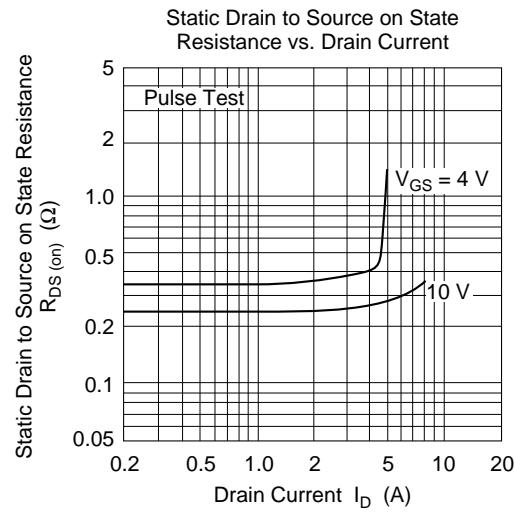
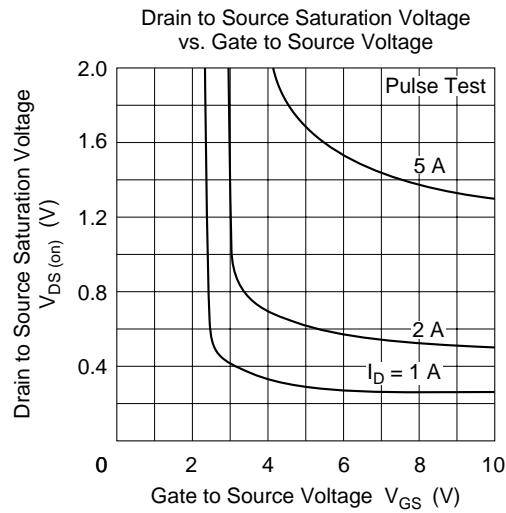
Table 2 Electrical Characteristics (Ta = 25°C)

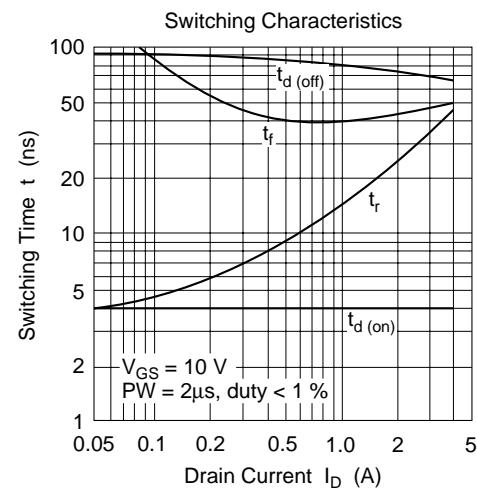
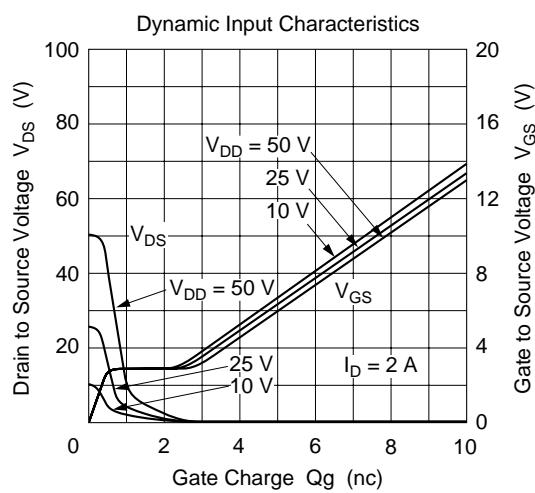
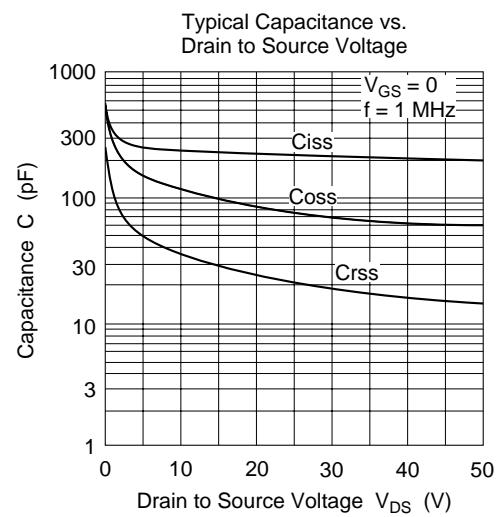
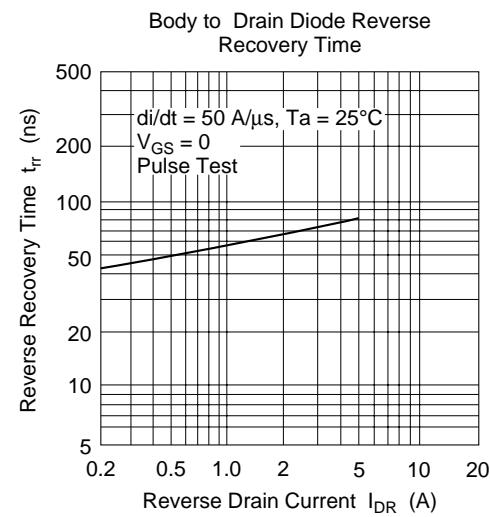
| Item | Symbol | Min | Typ | Max | Unit | Test conditions |
|--|----------------------|-----|------|------|------|---|
| Drain to source breakdown voltage | V _{(BR)DSS} | 60 | — | — | V | I _D = 10 mA, V _{GS} = 0 |
| Gate to source breakdown voltage | V _{(BR)GSS} | ±20 | — | — | V | I _G = ±100 μA, V _{DS} = 0 |
| Gate to source leak current | I _{GSS} | — | — | ±10 | μA | V _{GS} = ±16 V, V _{DS} = 0 |
| Zero gate voltage drain current | I _{DSS} | — | — | 100 | μA | V _{DS} = 50 V, V _{GS} = 0 |
| Gate to source cutoff voltage | V _{GS(off)} | 1.0 | — | 2.0 | V | I _D = 1 mA, V _{DS} = 10 V |
| Static drain to source on state resistance | R _{DS(on)} | — | 0.25 | 0.35 | Ω | I _D = 1 A, V _{GS} = 10 V * |
| | | | 0.40 | 0.50 | | I _D = 1 A, V _{GS} = 4 V * |
| Forward transfer admittance | y _{fs} | 1.2 | 2.0 | — | S | I _D = 1 A, V _{DS} = 10 V * |
| Input capacitance | C _{iss} | — | 240 | — | pF | V _{DS} = 10 V, V _{GS} = 0, |
| Output capacitance | C _{oss} | — | 115 | — | pF | f = 1 MHz |
| Reverse transfer capacitance | C _{rss} | — | 35 | — | pF | |
| Turn-on delay time | t _{d(on)} | — | 4 | — | ns | I _D = 1 A, V _{GS} = 10 V, |
| Rise time | t _r | — | 15 | — | ns | R _L = 30 Ω |
| Turn-off delay time | t _{d(off)} | — | 80 | — | ns | |
| Fall time | t _f | — | 40 | — | ns | |
| Body to drain diode forward voltage | V _{DF} | — | 1.0 | — | V | I _F = 2 A, V _{GS} = 0 |
| Body to drain diode reverse recovery time | t _{rr} | — | 70 | — | ns | I _F = 2 A, V _{GS} = 0, di _F /dt = 50 A/μs |

* Pulse Test



2SK973 (L), 2SK973 (S)





2SK973 (L), 2SK973 (S)

